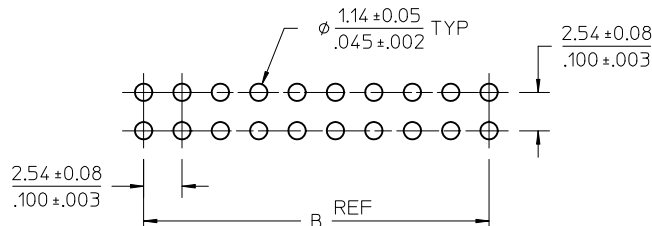
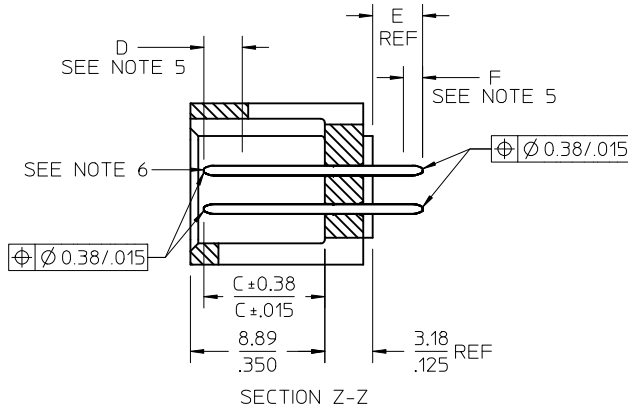


OPTION A



PCB LAYOUT: COMPONENT SIDE
TYPICAL PCB THICKNESS: 2.36/.093



NOTES:

- MATERIAL: SHROUDED WAFER: GLASS FILLED, LIQUID CRYSTAL POLYMER, COLOR: BLACK, 94V-0. PINS: COPPER ALLOY.
- PLATING:
 - TIN 0.00381/.000150 MINIMUM TIN, OVER NICKEL UNDERPLATE OVERALL
 - 15 GOLD 0.00038/.000015 MINIMUM GOLD PLATE IN SELECTED AREA
 - 0.00191/.000075 MINIMUM TIN IN SELECTED AREA OVER NICKEL UNDERPLATE OVERALL
 - 30 GOLD 0.00076/.000030 MINIMUM GOLD PLATE IN SELECTED AREA
 - 0.00191/.000075 MINIMUM TIN IN SELECTED AREA, OVER NICKEL UNDERPLATE OVERALL
- PRODUCT SPECIFICATION: PS-70567.
- PACKAGING: SEE CHARTS
- MEASURE POINT FOR PLATING THICKNESS.
- PIN PUSHOUT FORCE: 4 LBS. MINIMUM IN DIRECTION INDICATED.
- FOR ILLUSTRATION PURPOSES, 20 (DUAL 10) CIRCUIT SIZE HEADER SHOWN.
- PIN SOLDERABILITY PER MOLEX SPEC. SMES-152.
- WINDOW NOT AVAILABLE ON 6 OR 8 CIRCUIT SIZE.
- THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.



CKT	DIM A	DIM B	DIM L	DIM M	DIM N
06	8.43 .332	5.08 .200	1.68 .066	1.68 .066	
08	10.97 .432	7.62 .300	1.68 .066	1.68 .066	
10	13.51 .532	10.16 .400	1.68 .066	4.22 .166	
12	16.05 .632	12.70 .500	1.68 .066	4.22 .166	
14	18.59 .732	15.24 .600	1.68 .066	6.76 .266	
16	21.13 .832	17.78 .700	1.68 .066	6.76 .266	
18	23.67 .932	20.32 .800	1.68 .066	9.30 .366	
20	26.21 1.032	22.86 .900	1.68 .066	1.68 .066	19.46 .766
22	28.75 1.132	25.40 1.000	1.68 .066	1.68 .066	22.00 .866
24	31.29 1.232	27.94 1.100	1.68 .066	1.68 .066	24.54 .966
26	33.83 1.332	30.48 1.200	1.68 .066	1.68 .066	27.08 1.066
28	36.37 1.432	33.02 1.300	1.68 .066	1.68 .066	29.62 1.166
30	38.91 1.532	35.56 1.400	1.68 .066	1.68 .066	32.16 1.266
32	41.45 1.632	38.10 1.500	1.68 .066	1.68 .066	34.70 1.366
34	43.99 1.732	40.64 1.600	1.68 .066	1.68 .066	37.24 1.466
36	46.53 1.832	43.18 1.700	1.68 .066	1.68 .066	39.78 1.566
38	49.07 1.932	45.72 1.800	1.68 .066	1.68 .066	42.32 1.666
40	51.61 2.032	48.26 1.900	1.68 .066	1.68 .066	44.86 1.766
42	54.15 2.132	50.80 2.000	1.68 .066	1.68 .066	47.40 1.866
44	56.69 2.232	53.34 2.100	1.68 .066	1.68 .066	49.94 1.966
46	59.23 2.332	55.88 2.200	1.68 .066	1.68 .066	52.48 2.066
48	61.77 2.432	58.42 2.300	1.68 .066	1.68 .066	55.02 2.166
50	64.31 2.532	60.96 2.400	1.68 .066	1.68 .066	57.56 2.266
52	66.85 2.632	63.50 2.500	1.68 .066	1.68 .066	60.10 2.366
54	69.39 2.732	66.04 2.600	1.68 .066	1.68 .066	62.64 2.466
56	71.93 2.832	68.58 2.700	1.68 .066	1.68 .066	65.18 2.566
58	74.47 2.932	71.12 2.800	1.68 .066	1.68 .066	67.72 2.666
60	77.01 3.032	73.66 2.900	1.68 .066	1.68 .066	70.26 2.766
62	79.55 3.132	76.20 3.000	1.68 .066	1.68 .066	72.80 2.866
64	82.09 3.232	78.74 3.100	1.68 .066	1.68 .066	75.34 2.966
66	84.63 3.332	81.28 3.200	1.68 .066	1.68 .066	77.88 3.066
68	87.17 3.432	83.82 3.300	1.68 .066	1.68 .066	80.42 3.166
70	89.71 3.532	86.36 3.400	1.68 .066	1.68 .066	82.96 3.266
72	92.25 3.632	88.90 3.500	1.68 .066	1.68 .066	85.50 3.366

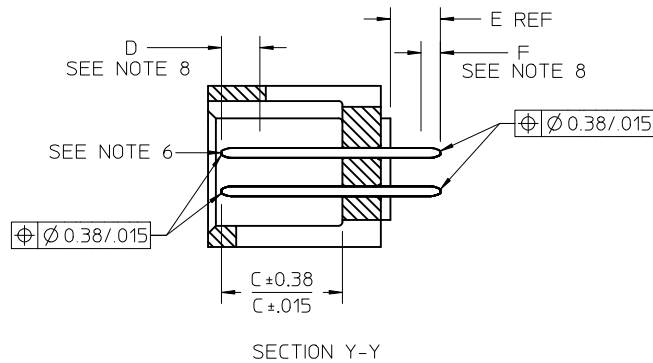
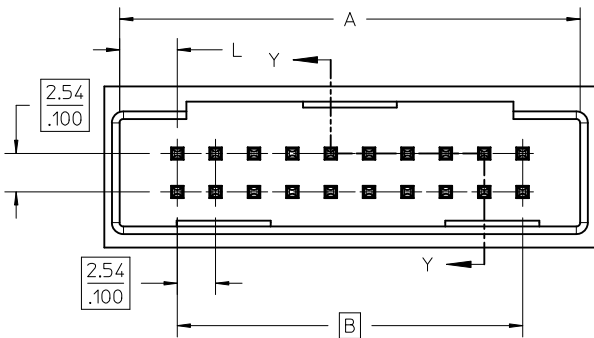
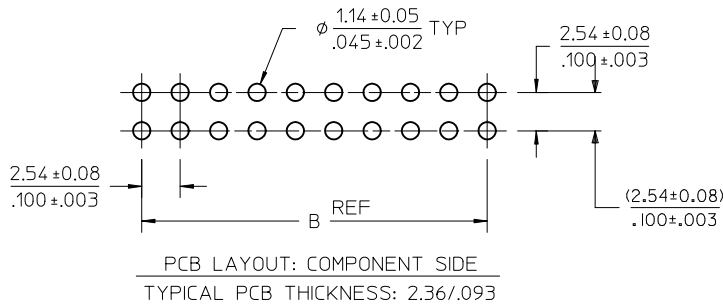
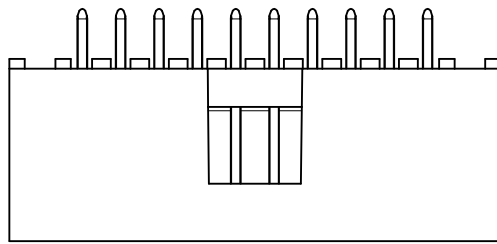
REV	DESCRIPTION	QUALITY SYMBOLS
J	CORRECT PCB HOLE SIZE	▽=0
	EC NO: UCP2011-0294	▽=0
	DRWINAS BARRA 2010/08/02	▽=0
	CHYKD:DRORGAN 1988/03/10	
	IAPPR:MBANAKIS 2010/08/03	

GENERAL TOLERANCES (UNLESS SPECIFIED)	
mm	INCH
4 PLACES ± .005	± .005
3 PLACES ± .010	± .010
2 PLACES ± 0.13	± .010
1 PLACE ± 0.25	± .010
ANGULAR ± 1/2°	

DIMENSION STYLE	
MM/IN	
DRAWN BY	DATE
EIK	1988/03/10
CHECKED BY	DATE
EIK	1988/03/10
APPROVED BY	DATE
SMILLER	2010/03/31

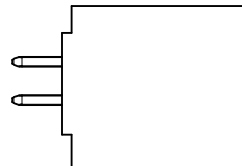
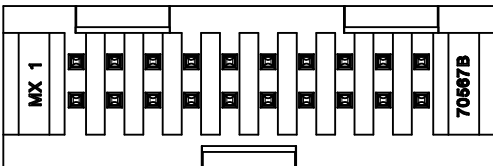
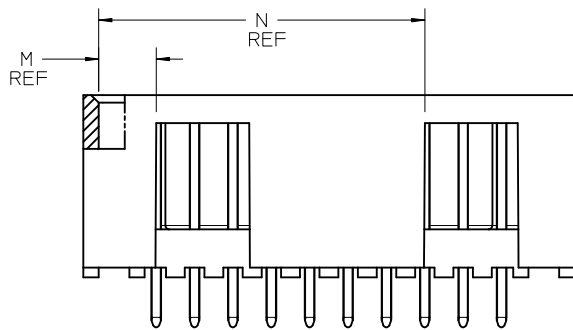
SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
4:1	INCH	THIRD ANGLE PROJECTION
4 SIDES SHROUDED HEADER HIGH TEMP, (2.54)/.100 GRID W/ (.64)/.025 PINS		
molex MOLEX INCORPORATED		
MATERIAL NO.	DOCUMENT NO.	SHEET NO.
SEE TABLE	SDA-70567-****	1 OF 5
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OPTION B



NOTES:

- MATERIAL: SHROUDED WAFER: 30% G.F. LCP, COLOR: BLACK, 94V-0. PINS: COPPER ALLOY.
- PLATING:
 TIN - (0.00381)/.000150 MINIMUM TIN OVER NICKEL UNDERPLATE OVERALL
 15 GOLD - (0.000381)/.000015 MINIMUM GOLD PLATE IN SELECTED AREA
 (0.00191)/.000075 MINIMUM TIN IN SELECTED AREA, OVER NICKEL UNDERPLATE OVERALL
 30 GOLD - (0.000761)/.000030 MINIMUM GOLD PLATE IN SELECTED AREA
 (0.00191)/.000075 MINIMUM TIN IN SELECTED AREA, OVER NICKEL UNDERPLATE OVERALL
- PRODUCT SPECIFICATION: PS-70567.
- PACKAGING: SEE CHARTS
- PIN PUSHOUT FORCE: 4 LBS. MIN IN DIRECTION INDICATED.
- FOR ILLUSTRATION PURPOSES, 20 (DUAL 10) CIRCUIT SIZE HEADER SHOWN.
- PIN SOLDERABILITY PER MOLEX SPEC. SMES-152.
- MEASURE POINT FOR PLATING THICKNESS.
- WINDOW IS NOT AVAILABLE ON 6 CIRCUIT.
- THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPECIFICATION PS-45499-002.
- SEE SHEET 1 FOR ALL OTHER DIMENSIONS



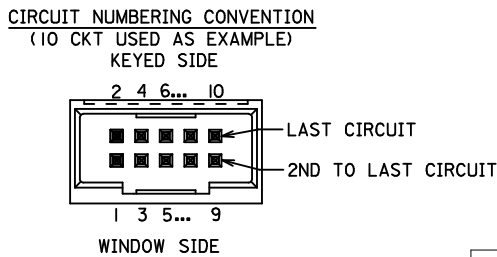
CKT	DIM A	DIM B	DIM L	DIM M	DIM N
06	12.70	5.08	3.81	3.81	---
	.500	.200	.150	.150	---
08	15.24	7.62	3.81	3.81	---
	.600	.300	.150	.150	---
10	17.78	10.16	3.81	6.35	---
	.700	.400	.150	.150	---
12	20.32	12.70	3.81	6.35	---
	.800	.500	.150	.150	---
14	22.86	15.24	3.81	8.89	---
	.900	.600	.150	.350	---
16	25.40	17.78	3.81	8.89	---
	1.000	.700	.150	.350	---
18	27.94	20.32	3.81	11.43	---
	1.100	.800	.150	.450	---
20	30.48	22.86	3.81	3.81	21.59
	1.200	.900	.150	.150	.850
22	33.02	25.40	3.81	3.81	24.13
	1.300	1.000	.150	.150	.950
24	35.56	27.94	3.81	3.81	26.67
	1.400	1.100	.150	.150	1.050
26	38.10	30.48	3.81	3.81	29.21
	1.500	1.200	.150	.150	1.150
28	40.64	33.02	3.81	3.81	31.75
	1.600	1.300	.150	.150	1.250
30	43.18	35.56	3.81	3.81	34.29
	1.700	1.400	.150	.150	1.350
32	45.72	38.10	3.81	3.81	36.83
	1.800	1.500	.150	.150	1.450
34	48.26	40.64	3.81	3.81	39.37
	1.900	1.600	.150	.150	1.550
36	50.80	43.18	3.81	3.81	41.91
	2.000	1.700	.150	.150	1.650
38	53.34	45.72	3.81	3.81	44.45
	2.100	1.800	.150	.150	1.750
40	55.88	48.26	3.81	3.81	46.99
	2.200	1.900	.150	.150	1.850
42	58.42	50.80	3.81	3.81	49.53
	2.300	2.000	.150	.150	1.950
44	60.96	53.34	3.81	3.81	52.07
	2.400	2.100	.150	.150	2.050
46	63.50	55.88	3.81	3.81	54.61
	2.500	2.200	.150	.150	2.150
48	66.04	58.42	3.81	3.81	57.15
	2.600	2.300	.150	.150	2.250
50	68.58	60.96	3.81	3.81	59.69
	2.700	2.400	.150	.150	2.350
52	71.12	63.50	3.81	3.81	62.23
	2.800	2.500	.150	.150	2.450
54	73.66	66.04	3.81	3.81	64.77
	2.900	2.600	.150	.150	2.550
56	76.20	68.58	3.81	3.81	67.31
	3.000	2.700	.150	.150	2.650
58	78.74	71.12	3.81	3.81	69.85
	3.100	2.800	.150	.150	2.750
60	81.28	73.66	3.81	3.81	72.39
	3.200	2.900	.150	.150	2.850
62	83.82	76.20	3.81	3.81	74.93
	3.300	3.000	.150	.150	2.950
64	86.36	78.74	3.81	3.81	77.47
	3.400	3.100	.150	.150	3.050
66	88.90	81.28	3.81	3.81	80.01
	3.500	3.200	.150	.150	3.150
68	91.44	83.82	3.81	3.81	82.55
	3.600	3.300	.150	.150	3.250
70	93.98	86.36	3.81	3.81	85.09
	3.700	3.400	.150	.150	3.350
72	96.52	88.90	3.81	3.81	87.63
	3.800	3.500	.150	.150	3.450

CORRECT PCB HOLE SIZE IEC NO: UCP2011-0294 DRWN:MS BARRA 2010/08/02 CHKD:DWORGAN 1988/03/10 APPR:MBANKS 2010/08/03	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM/IN		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	
		mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± .005 2 PLACES ± 0.13 ± .010 1 PLACE ± 0.25 ± --- ANGULAR ± 1/2°		DRAWN BY DATE EIK 1988/03/10 CHECKED BY DATE EIK 1988/03/10 APPROVED BY DATE MILLER 2010/03/31		4 SIDES SHROUDED HEADER HIGH TEMP, (2.54)/.100 GRID W/ (.64)/.025 PINS			
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE TABLE		MOLEX MOLEX INCORPORATED SDA-70567-****			
				MATERIAL NO.		DOCUMENT NO.		SHEET NO. 2 OF 5	

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SPECIAL - WITH VOIDS

CKTS SIZE	ENGINEERING NUMBER A-70567	EDP NUMBER	E REF.	C ±.015 (0.38)	K ±.015 (0.38)	VOID CKTS	CONNECTOR END PLATING			P.C. BOARD END PLATING			PACKAGING INFORMATION PK-70873-
							TYPE		D MEAS.	TYPE		F MEAS.	
10	-9003	70567-9003	.130 (3.30)	.315 (8.00)	.415 (10.54)	10	GOLD		.100 (2.54)	TIN		.050 (.127)	0018



SEE SHEETS 1 & 2 EC NO: UCP2011-0294 DRWN:MSI:BARA 2010/08/02 CHKD:DMORGAN 1988/03/10 APPR:MBANKIS 2010/08/03	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE		SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	
			MM/IN		4:1	INCH		
		4 PLACES ±.013 ±.010	mm	INCH	DRAWN BY DATE	TITLE		
		3 PLACES ±.013 ±.010			EIK 1988/03/10	4 SIDES SHROUDED HEADER		
2 PLACES ±.013 ±.010			CHECKED BY DATE	HIGH TEMP. (2.54)/.100				
1 PLACE ±.013 ±.010			EIK 1988/03/10	GRID W/ (.64)/.025 PINS				
ANGULAR ±1/2°			APPROVED BY DATE	MOLEX INCORPORATED				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MILLER 2010/03/31	SEE TABLE				
		SIZE	MATERIAL NO.	DOCUMENT NO.	SDA-70567-****	SHEET NO.		
		(C)				5 OF 5		
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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Факс: 8 (812) 320-02-42

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